PCN Number:		20160621001					PCN Da	te: 06/22/2016		
Title:	Datasheet fo	r SN74LV123	8A-	Q1						
Custom	er Contact:	PCN Manager				Dept:			Quality Services	
Change	Type:									
Assembly Site							Wafer	Wafer Bump Site		
Assembly Process		\boxtimes	□ Data Sheet			Wafer	er Bump Material			
Assembly Materials			Part number cl	hange		Wafer	Wafer Bump Process			
Mechanical Specification				Test Site				Wafer Fab Site		
Packing/Shipping/Labeling				Test Process Wafer Fab M						
□ Wafer Fab Process									Process	
Notification Details										
Description of Change:										
Texas Instruments Incorporated is announcing an information only notification. The product datasheet(s) is updated, previous maximum operating free-air temperature										
	ly stated as 1					,				
The felle	ina ahanaa l	niatowy provid		fuuthau dataila "	Thasa shans				wad at the	
The following change history provides further details. These changes may be reviewed at the datasheet links provided.										
							-	I TE	XAS STRUMENTS	
SN74LV1	23A-Q1							- 114	STROMENTS	
SCLS467F - F	FEBRUARY 2003-REVI	SED JUNE 2016							www.ti.com	
Changes	Changes from Revision E (December 2012) to Revision F Page									
Deleted 200-V Machine Model (A115-A) from Features										
 Added 	l 'Infotainment Syst	ems' application							1	
 Added 	Added 'Infotainment Systems' application. Added 'DVD and Blu-ray Players' application. 1									
 Added 	ALL HORON IN FOR THE PARTY OF T									
Added 'Advanced Driver Assistance Systems' application.										
Added 'Automotive Body and Lighting' application										
Updated the data sheet to meet the new TI data sheet standard										
Deleted Ordering Information table from the data sheet										
 Moved 	Moved extraneous description details to Overview section									
				able, Pin Configuration						
	section, Application and Implementation section, Power Supply Recommendations section, Layout section, Device and Documentation Support section, Receiving Notification of Documentation Updates section, and Mechanical,									
Packaging, and Orderable Information section										
Added Operating virtual junction temperature, T _J to <i>Absolute Maximum Ratings</i> table										
Changed Maximum Operating free-air temperature from 105 to 125										
Device	Family				Change Fror	n:	(Chan	ge To:	
	SN74LV123A-Q1			SCLS467E					467F	
These ch	nanges may be	reviewed at	the	e datasheet links	provided.					
http://www.ti.com/lit/ds/symlink/sn74lv123a-q1.pdf										
•										
Reason for Change:										
To more accurately reflect device characteristics.										
Anticipated impact on Fit, Form, Function, Quality or Reliability (positive / negative):										
No anticipated impact. This is a specification change announcement only. There are no changes to the actual device.										
Changes to product identification resulting from this PCN:										
None.										
	: Affected:									
	/123ATDWDC/			1 011=	41 \/1 22 ATD\	VD 0				

For questions regarding this notice, e-mails can be sent to the regional contacts shown below or your local Field Sales Representative.

Location	E-Mail
USA	PCNAmericasContact@list.ti.com
Europe	PCNEuropeContact@list.ti.com
Asia Pacific	PCNAsiaContact@list.ti.com
Japan	PCNJapanContact@list.ti.com